ACX
Advanced Ceramic X

LF 2012 Series

Multilayer Chip Low-Pass Filters

Features

❖Ultra-small, low-profile and light-weight low pass filter

Applications

❖High harmonic rejection up to 5GHz.

Specifications

Part Number	Frequency Range (MHz)	Insertion Loss @ BW (dB)	Attn. I @ 824 ~ 960 MHz (dB)	Attn. II @ 1.71 ~ 1.99 GHz(dB)	Attn. III @ 2.4 ~ 4.0 GHz(dB)	VSWR @ BW
LF2012-ER50FAA_	0 ~500	0.70 max.	9 min.	25 min.	25 min.	2.0 max.

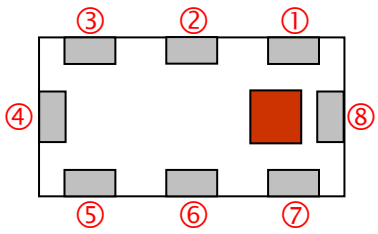
Q'ty/Reel (pcs) : 4,000
Operating Temperature Range : -40 ~ +85 °C
Storage Temperature Range : -40 ~ +85 °C
Storage Period : 12 months max.
Power Capacity : 1W max.

Part Number

LF ① 2012 ② - E ③ R50 ④ FAA ⑤ □ ⑥ /LF ⑦

① Type	LF : Low Pass Filter	② Dimensions (L × W)	2.0 × 1.2 mm
③ Material Code	E	④ Frequency Range	R50=500MHz
⑤ Specification Code	FAA	⑥ Packaging	T: Tape & Reel B: Bulk
⑦ Soldering	=lead-containing /LF=lead-free		

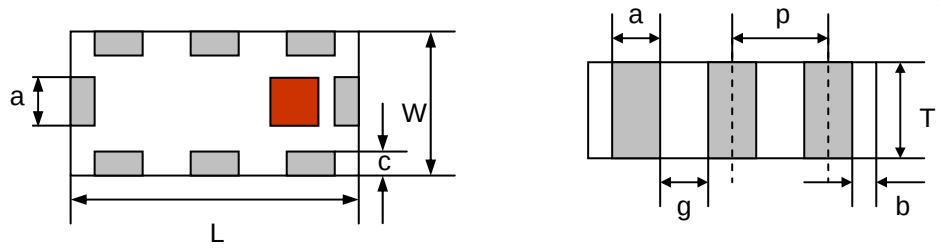
Terminal Configuration



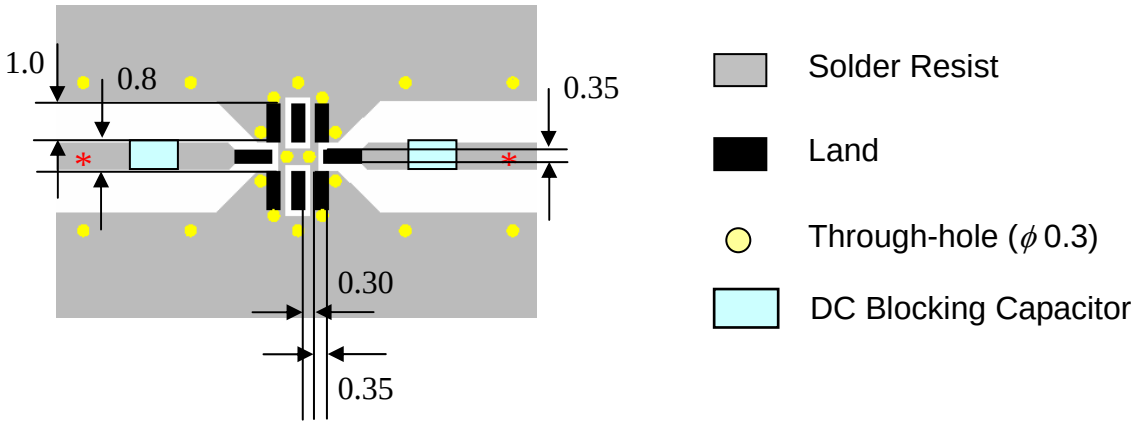
No.	Terminal Name	No.	Terminal Name
①	GND	⑤	GND
②	NC	⑥	NC
③	GND	⑦	GND
④	OUT	⑧	IN

Dimensions and Recommended PC Board Pattern

Unit : mm



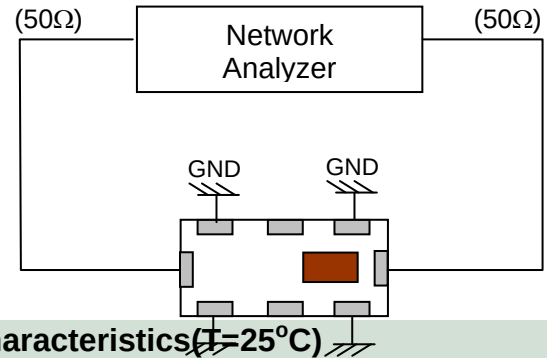
Mark	L	W	T	a	b	c	g	p
Dimensions	2.0 ± 0.1	1.25 ± 0.1	0.95 ± 0.1	0.3 ± 0.1	0.2 ± 0.1	0.3+0.1 /-0.2	0.35 ± 0.1	0.65 ± 0.05



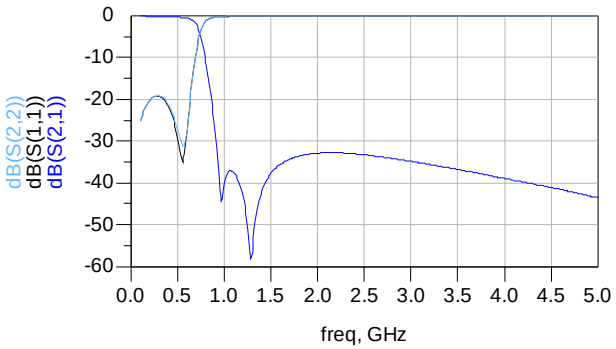
* Line width should be designed to match 50 Ω characteristic impedance, depending on PCB material and thickness.

* DC Blocking capacitor is connected in series at each In/Out Port.

Measuring Diagram



Typical Electrical Characteristics(T=25°C)



Notes

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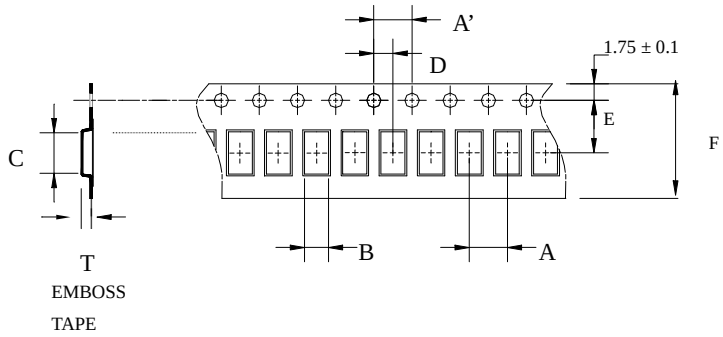
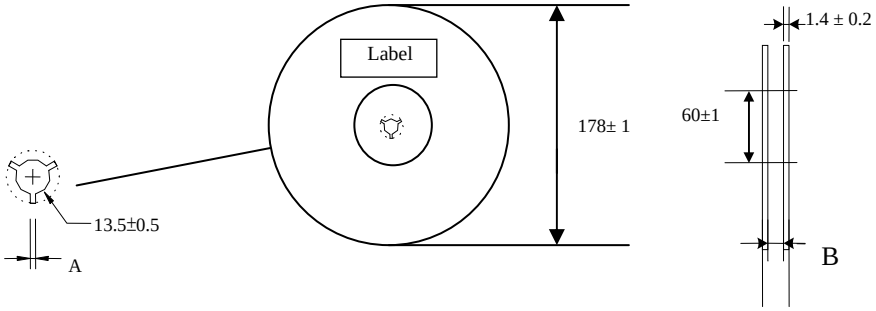
Taping Specifications

❖Tape Dimensions (Unit: mm) & Quantity



Type	A	A'	B	C	D	E	F	T	Quantity/reel	Tape material
2012	4.0± 0.1	4.0± 0.1	1.35± 0.05	2.15± 0.05	2.0± 0.05	3.5± 0.1	8.0± 0.1	1.08± 0.05	4,000pcs	Plastic (Embossed)

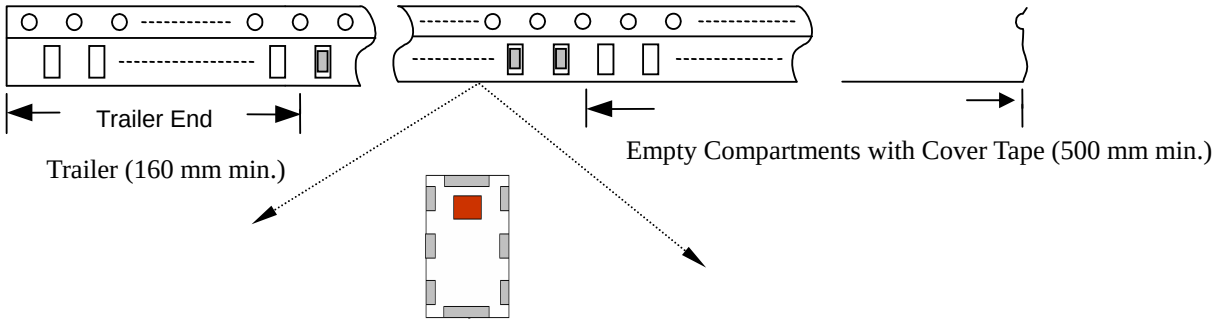
❖Reel Dimensions (Unit: mm)



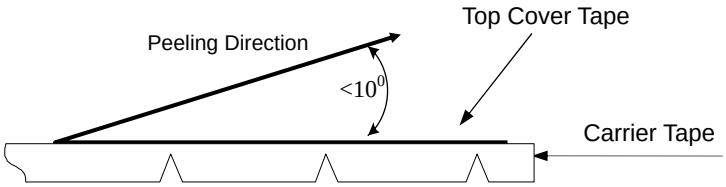
Label: Customer's Name,
ACX P/N, Q'ty, Date,
ACX Corp.

Type	A	B
2012	2.3±0.5	9.0±0.3

❖Leader and Trailer Tape



❖**Peel-off Force**



Peel-off force should be in the range of 0.1 – 0.6 N at a peel-off speed of 300±10 mm/min .

❖**Storage Conditions**

(1) Temperature: +5 ~35℃, relative humidity (RH): 45~75%.
(2) Non-corrosive environment.

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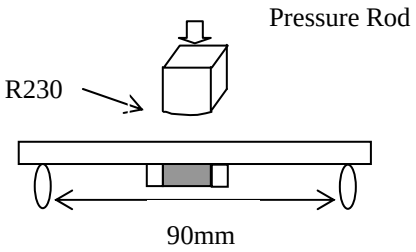
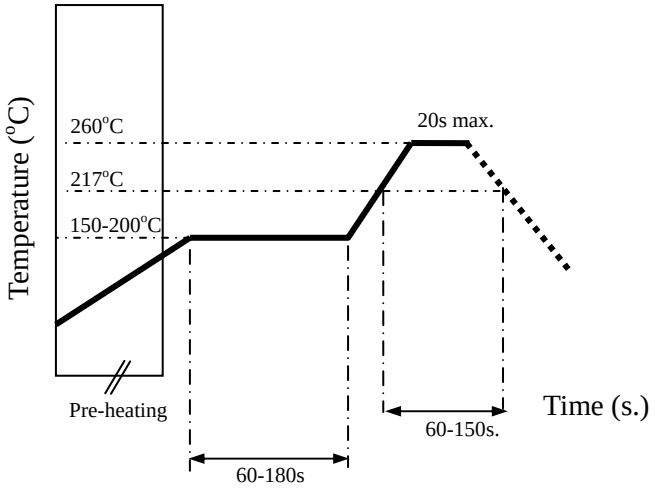
Mechanical & Environmental Characteristics

Item	Requirements	Procedure
Solderability	1. No apparent damage 2. More than 95% of the terminal electrode shall be covered with new solder	1. Preheat: 120± 5 °C 2. Solder: 245± 5°C for 5± 1 sec
Soldering strength (Termination Adhesion)	1. 1kg minimum	1. Solder specimen onto test jig. 2. Apply push force at 0.5mm/s until electrode pads are peeled off or ceramic are broken. Pushing force is applied to longitude direction
Deflection (Substrate Bending)	1. No apparent damage	1. Solder specimen onto test jig (FR4, 0.8mm) using the recommend soldering profile. 2. Apply a bending force of 2mm deflection 
Heat/Humidity Resistance	1. No apparent damage 2. Fulfill the electrical specification after test	1. Temperature: 85± 2°C 2. Humidity: 90% ~ 95% RH 3. Duration: 1000±48hrs 4. Recovery: 1-2hrs
Thermal shock (Temperature Cycle)	1. No apparent damage 2. Fulfill the electrical specification after test	1. One cycle/step 1：125 ± 5°C for 30 min step 2：- 40 ± 5°C for 30 min 2. No of cycles：100 3. Recovery:1-2 hrs
Low Temperature Resistance	1. No apparent damage 2. Fulfill the electrical specification after test	1. Temperature: -40°± 5 °C 2. Duration: 500 ±24hrs 3. Recovery: 1-2hrs

Soldering Conditions

❖**Typical Soldering Profile for Lead-free Process**

Reflow Soldering :



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